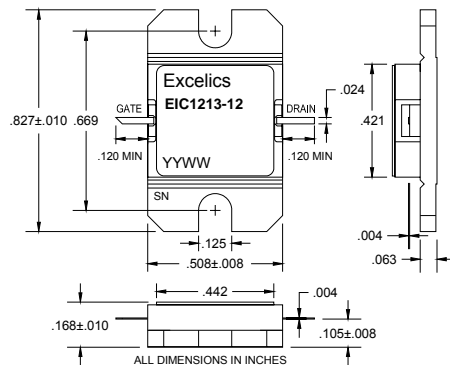


ISSUED 3-19-09

## 12.75-13.25 GHz 12-Watt Internally Matched Power FET

### FEATURES

- 12.75– 13.25 GHz Bandwidth
- Input/Output Impedance Matched to 50 Ohms
- +41 dBm Output Power at 1dB Compression
- 6 dB Power Gain at 1dB Compression
- 25% Power Added Efficiency
- Hermetic Metal Flange Package
- 100% Tested for DC, RF, and  $R_{TH}$



### ELECTRICAL CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )



Caution! ESD sensitive device.

SYMBOL	PARAMETERS/TEST CONDITIONS <sup>1</sup>	MIN	TYP	MAX	UNITS
$P_{1dB}$	Output Power at 1dB Compression $V_{DS} = 10\text{ V}$ , $I_{DSQ} \approx 3700\text{mA}$ $f = 12.75\text{-}13.25\text{GHz}$	40.5	41		dBm
$G_{1dB}$	Gain at 1dB Compression $V_{DS} = 10\text{ V}$ , $I_{DSQ} \approx 3700\text{mA}$ $f = 12.75\text{-}13.25\text{GHz}$	5	6		dB
$\Delta G$	Gain Flatness $V_{DS} = 10\text{ V}$ , $I_{DSQ} \approx 3700\text{mA}$ $f = 12.75\text{-}13.25\text{GHz}$			$\pm 0.6$	dB
IMD3	Output 3rd Order Intermodulation Distortion $\Delta f = 10\text{ MHz}$ 2-Tone Test; $P_{out} = 30.0\text{ dBm S.C.L.}^2$ $V_{DS} = 10\text{ V}$ , $I_{DSQ} \approx 65\% IDSS$ $f = 13.25\text{ GHz}$	-41	-45		dBc
PAE	Power Added Efficiency at 1dB Compression $V_{DS} = 10\text{ V}$ , $I_{DSQ} \approx 3700\text{mA}$ $f = 12.75\text{-}13.25\text{GHz}$		25		%
$I_{d1dB}$	Drain Current at 1dB Compression $f = 12.75\text{-}13.25\text{GHz}$		3800	4300	mA
$I_{DSS}$	Saturated Drain Current $V_{DS} = 3\text{ V}$ , $V_{GS} = 0\text{ V}$		8	10	A
$V_P$	Pinch-off Voltage $V_{DS} = 3\text{ V}$ , $I_{DS} = 75\text{ mA}$		-2.5	-4.0	V
$R_{TH}$	Thermal Resistance <sup>3</sup>		1.8	2.1	$^\circ\text{C/W}$

Note: 1) Tested with 30 Ohm gate resistor.

2) S.C.L. = Single Carrier Level.

3) Overall  $R_{th}$  depends on case mounting.

### MAXIMUM RATING AT $25^\circ\text{C}$ <sup>1,2</sup>

SYMBOLS	PARAMETERS	ABSOLUTE <sup>1</sup>	CONTINUOUS <sup>2</sup>
$V_{ds}$	Drain-Source Voltage	15	10V
$V_{gs}$	Gate-Source Voltage	-5	-4V
$P_{in}$	Input Power	37.5dBm	@ 3dB Compression
$T_{ch}$	Channel Temperature	175 $^\circ\text{C}$	175 $^\circ\text{C}$
$T_{stg}$	Storage Temperature	-65 to +175 $^\circ\text{C}$	-65 to +175 $^\circ\text{C}$
$P_t$	Total Power Dissipation	71.5W	71.5W

Note: 1. Exceeding any of the above ratings may result in permanent damage.

2. Exceeding any of the above ratings may reduce MTTF below design goals.

Specifications are subject to change without notice.

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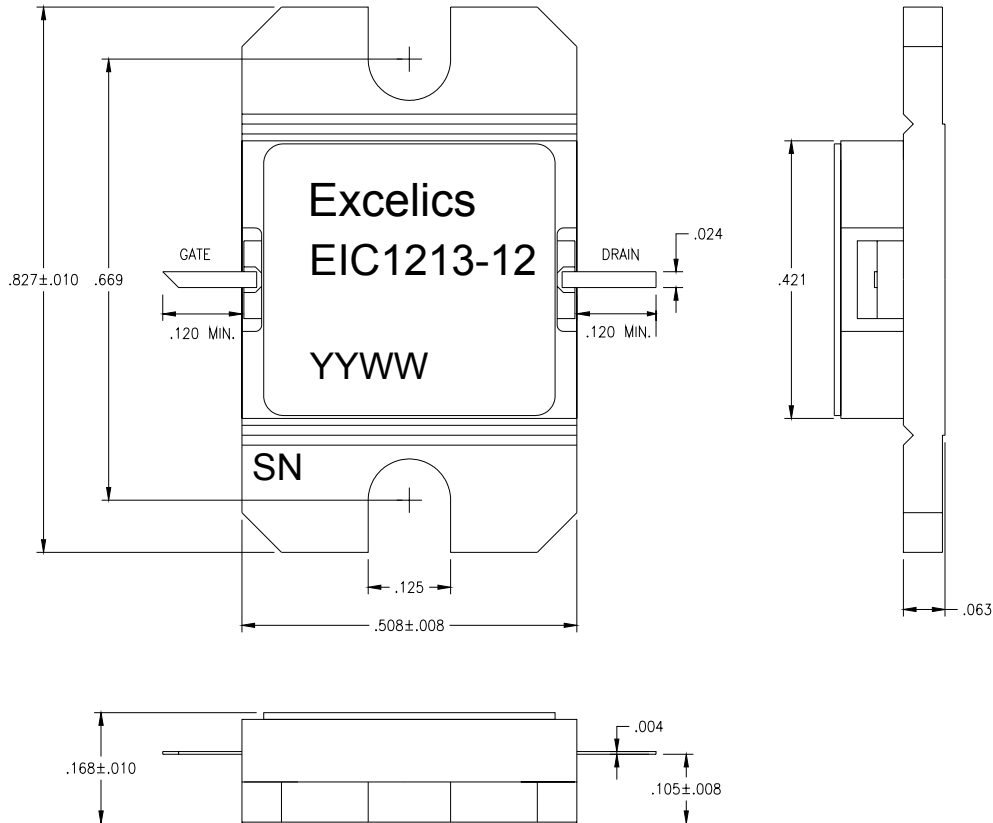
Revision A1

ISSUED 3-19-09

## 12.75-13.25 GHz 12-Watt Internally Matched Power FET

### PACKAGE OUTLINE

Dimensions in inches, Tolerance  $\pm .005$  unless otherwise specified



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AS HERE IN:

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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